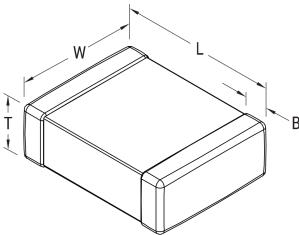


CBR02C330G3GAC

CBR-SMD RF COG, Ceramic, 33 pF, 2%, 25 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0201



Click here for the 3D model.

Dimensions	
Chip Size	0201
L	0.6mm +/-0.03mm
W	0.3mm +/-0.03mm
Т	0.3mm +/-0.03mm
В	0.15mm +/-0.05mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	15000

General Information	
Series	CBR-SMD RF COG
Style	SMD Chip
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	0.3 mg
Notes	Solder Reflow Only.
Shelf Life	78 Weeks
MSL	1

33 pF
2%
25 VDC
62.5 VDC
-55/+125°C
COG
0.1%
0% Loss/Decade Hour
10 GOhms
1000

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